

Resistance calculation in metal-2D contacts: Accuracy of numerical integration

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INTRODUCTION

Ab-initio modelling techniques provide ways to estimate the contact resistance of metal-2D contacts, and are important tools to understand and design these structures. However, due to the complicated nature of metal - 2D semiconductor contacts, the task of obtaining accurate, physically sound results that are consistent with experiment is daunting.

In this work, we investigate the validity of a widely used method for the calculation of contact resistance. Using our in-house quantum transport solver [1], [2], we compare the calculation of the transmission coefficient and contact resistance through a metal-2D contact using an analytical integration [2] and trapezoidal integration commonly used in ab-initio modelling approaches [3], [4]. It is necessary to carefully choose the integration method for the transmission coefficient [5].

CALCULATION OF CONTACT RESISTANCE

Figure 1a shows the structure of the Au-MoS₂ contact we simulate, with the Au ($\phi_{\text{Au}} = 5.2$ eV) in blue and the MoS₂ ($\chi_{\text{MoS}_2} = 4.2$ eV) in red. Figures 1b and 1c show the Hartree potential and free charge density, respectively, obtained by self-consistently solving the Poisson and Schrödinger equations [1].

Figure 2 shows the band structures of the Au and MoS₂ at the left and right edges of the simulation domain, where semi-infinite leads provide electron baths from which electrons are injected in the simulated structure. We describe the materials using a continuum effective mass model. Therefore, the bandstructures are those of free electrons with an effective mass m^* ($m^* = 1$ in this work).

We calculate the conductance from the transmis-

sion coefficient using

$$\sigma = \frac{2q^2}{h} \int_{-\infty}^{+\infty} dE \int_{-\infty}^{+\infty} dk_y T(E, k_y) \frac{\partial f_{\text{FD}}(E)}{\partial E}. \quad (1)$$

Here, $\frac{\partial f_{\text{FD}}(E)}{\partial E}$ is the derivative of the Fermi-Dirac distribution, and $T(E, k_y)$ is the transmission coefficient in the transport (x) direction at a certain energy E sampled at a value of k_y of the wave vector in the transverse direction.

Figure 3 shows the comparison between the analytical and trapezoidal integration methods for the calculation of $T(E) = \int dk_y T(E, k_y)$. Using our effective mass model, we are able to perform a transformation where we obtain $T(E)$ analytically [2]. Crucially, Fig. 3 shows that a small N_{k_y} can result in over- as well as underestimation of the transmission coefficient.

CONCLUSION

Figure 4 shows the convergence of the contact resistance w.r.t. the number of samples taken in the transverse (k_y) direction. We see that the trapezoidal integration is able to capture the behavior of the contact well when N_{k_y} is well-chosen.

Figure 5 shows that the relative error in the calculated contact resistance is strongly dependent on the choice of N_{k_y} . The choices for N_{k_y} that do not include the conduction band minimum are particularly erroneous at insufficiently large N_{k_y} . We conclude that even in advanced models, e.g. DFT+NEGF, it is important to carefully choose N_{k_y} .

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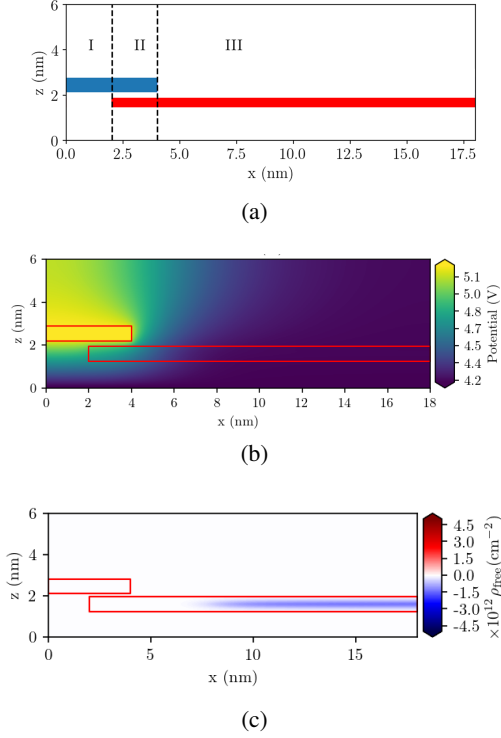


Fig. 1: (a) Schematic representation of our metal-2D semiconductor contact. Self-consistently calculated Hartree potential (b) and free charge density (c). The calculated Schottky barrier is 0.57 eV. We add a sheet doping of $\rho_{\text{sheet}} = 5 \times 10^{12} \text{ cm}^{-2}$.

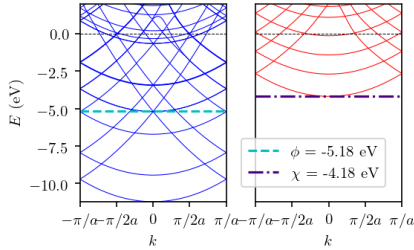


Fig. 2: Bandstructure of the materials at the left and right edges of the simulation domain and in the corresponding semi-infinite leads. The metal and semiconductor are at the left and right sides, respectively.

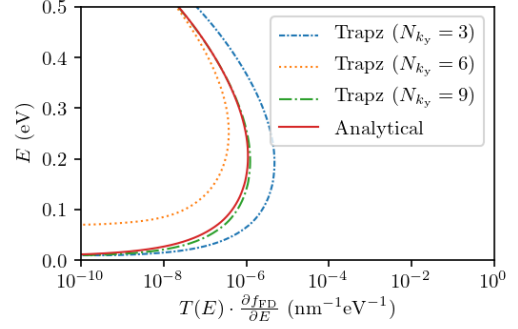


Fig. 3: The transmission coefficient, multiplied by the derivative of the Fermi-Dirac distribution, calculated using trapezoidal and analytical integration of $T(E) = \int dk_y T(E, k_y)$ for $N_{k_y} = 3$, $N_{k_y} = 6$ and $N_{k_y} = 9$.

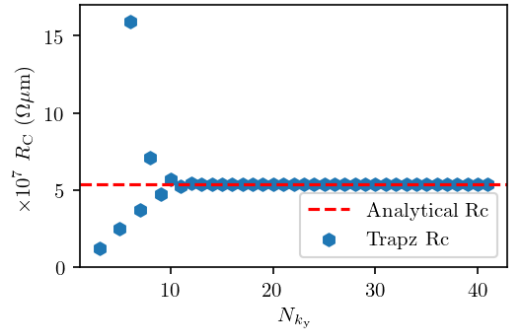


Fig. 4: Convergence of the contact resistance calculated using trapezoidal integration of the transmission coefficient, with varying number of samples in the transverse (k_y) direction. The analytically calculated value is shown as the dashed red line.

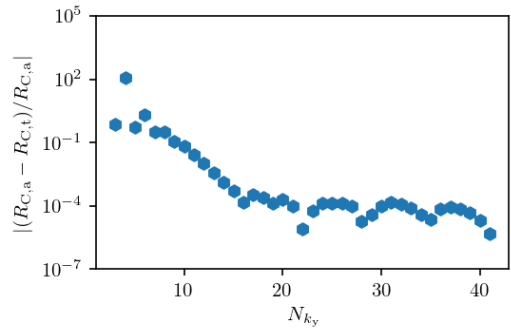


Fig. 5: Convergence of the relative error in the contact resistance between the trapezoidal and analytical integration methods for the transmission coefficient.